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2.	Name and	d Address of r	eceiving p	oarty(ies):			. (672 672
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3.	<u>X</u> A S C	conveyance: ssignment ecurity Agreer ther: Date(s): Se		 16, 2004	Merger Change of Nam	e			
4.	This d (a) T (b) T This d (a) P	he execution of the title is:MET OR locument is be	eing filed to date(s) of HOD OF eing filed a ion No(s).	ogether with a the application FABRICATIN after filing of th	new application: i is/are: <u>Septemb</u> G ELEMENT HAV e application: filed	ING MICR		JRE	
5.	STAAS & Attention: 1201 New	d address of p HALSEY LLP <u>H. J. Staas</u> York Ave., N on, D.C. 2000	.W., Suite		dence concerning Our Docket: 01:	<u>22.1605</u>	should be r		
6.	Total num	ber of applica	tions and	patents involv	ed			40.00 BP	
7.	<u>X</u> E	nclosed		(\$ 40.00 p I to deposit ac	er Assignment)				
8.	Deposit A (Attach du	ccount No.: 1 plicate copy o	9-3935 (of this pag	(Any underpay e if paying by	ment is authorized deposit account)	d to be cha	rged to this	Deposit Acco	ount)
9.	To the be	t and signature st of my know true copy of th	edge and		egoing information	n is true an	d correct an	d any attache	∍d
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[1] U.S. ASSIGNMENT

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-1, Kamikodanaka 4-chome, Nakahara-ku	, Kawasaki-shi,	Kanagawa 2	11-8588 Japa	an		
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ereinafter, "ASSIGNEE"), the receipt of which is her SSIGNEE the entire and exclusive right, title and inte litle of Invention)	erest to the invention	n entitled		ereby se	lls, assigns	and transfers to
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lating to International Patent Application PCT/JP	/ and/	or for which app	olication for Let	ters Pate	nt of the U	nited States was
secuted on even date herewith or, if not so executed,	was:					
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d to said application and all Letters Patent(s) of the l	United States granted	d on said applica	ation and any co	ontinuatio	on, division	n, renewal,
bstitute, reissue or reexamination application based the cluding any extensions thereof (collectively, hereinaf				_etters Pa	etent(s) ma	y be granted and
The ASSIGNOR agree(s), when requested by said A nich the ASSIGNEE may deem necessary, desirable						
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is to include but not be limited to executing all paper orn testimony, and obtaining and producing evidence		assignments ar	nd declarations,	taking al	l rightful o	oaths, providing
IN WITNESS WHEREOF, the undersigned invento (Typed Name & Signature of Inventor(s))	or(s) has (have) affix (Date		signature(s). (Typed Nat	me & Sig	mature of	Witness(es))
松下直久	Sep. 16.	2004	菠	٨	† 关	3
松下直久 Nachisa Matsushita 古井寿一	Sep. 16.	2004	Etsuko Tohy	/ama	1兒	3
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RECORDED: 10/19/2004